Document Number: STBV25150A2C Preliminary Datasheet V1.0

## GaN 50V, 150W, 2.45GHz RF Power Transistor

## **Description**

The STBV25150A2C is a single ended 150 watt capable, GaN HEMT, ideal for ISM applications at 2.45GHz. It can be used in CW, Pulse and any other modulation modes. There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

Typical RF performance at selected 2.4-2.5GHz applications with device soldered on heatsink
VDD = 50Vdc, Vgs=-4.5V



		•					
Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
2400	52.46	176.3	72.1	15.99	53.08	203.5	75.0
2450	52.01	159.0	74.9	16.41	52.59	181.5	77.4
2500	51.28	134.2	75.9	16.46	51.91	155.3	78.5

#### CW:

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
2400	52.39	173.2	70.3	15.4	52.87	193.6	72.3
2450	51.86	153.4	72.4	15.89	52.4	173.7	74.6
2500	51.21	132.3	74.3	15.99	51.81	151.8	76.7

## **Applications**

- 2.45GHz RF Energy
- S band power amplifier

### **Important Note: Proper Biasing Sequence for GaN HEMT Transistors**

#### **Turning the device ON**

- 1. Set VGS to the pinch--off (VP) voltage, typically -5~V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

## Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

**Table 1. Maximum Ratings** 

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+200	Vdc
GateSource Voltage	V <sub>GS</sub>	-8 to +0.5	Vdc
Operating Voltage	V <sub>DD</sub>	55	Vdc
Maximum gate current	Igs	21.6	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T <sub>C</sub>	+150	°C
Operating Junction Temperature	TJ	+225	°C

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#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Case by FEA	Rejc	1.6	°C /W	
T <sub>C</sub> = 85°C, at Pd=55W	RHJC	1.6	-C /VV	

Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

#### DC Characteristics (Each path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=21.6mA	V <sub>DSS</sub>		200		V
Gate Threshold Voltage	VDS =10V, ID = 21.6mA	$V_{GS(th)}$	-4	=	-2	V
Gate Quiescent Voltage	VDS =48V, IDS=190mA, Measured in Functional Test	$V_{GS(Q)}$		3.0		V

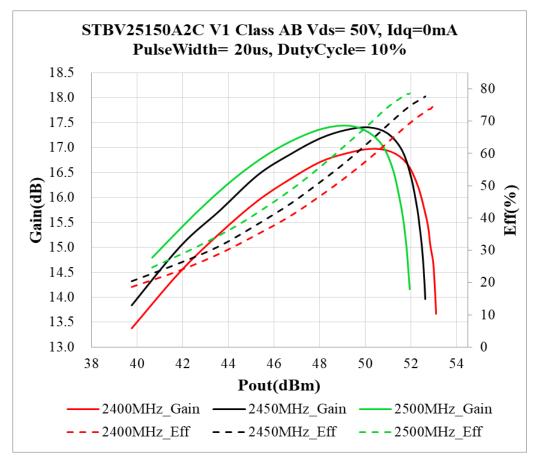
#### **Ruggedness Characteristics**

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.45GHz, Pout=150W pulse CW					
	All phase,	VSWR		10:1		
	No device damages					

## TYPICAL CHARACTERISTICS

Figure 1: Efficiency and power gain as function of Pout

(VDD = 50Vdc, Vgs=-4.5V, Pulse width=20us, duty cycle=10%)



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Figure 2: S11/S21 output from Network analyser

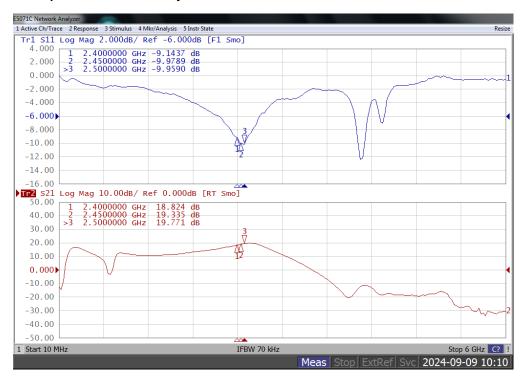
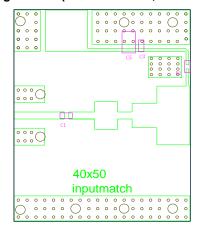
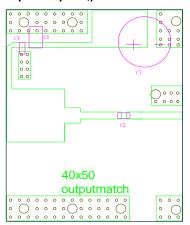


Figure 3: Reference design circuit (RO4350B 20mil, PCB DWG file upon request,)



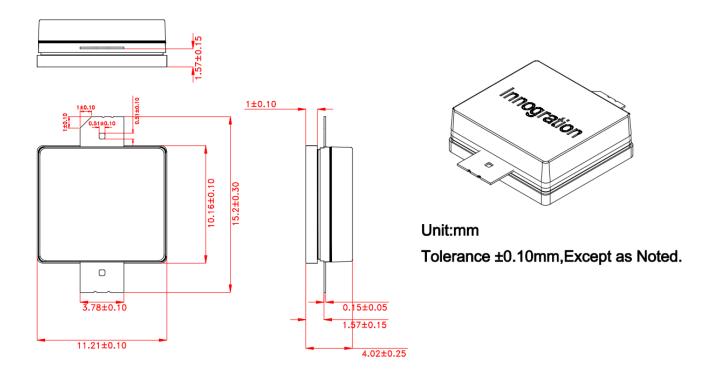


Designator	Comment	Comment Footprint	
C1, C2, C3, C4	12 pF	0805/1210 (HIGH Q)	4
C5, C6	10 uF/100V	1210	2
C7	100 uF/63V		1
R1	10 Ω	0603	1

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## Package Dimensions (Unit:mm)



### **Revision history**

Table 1. Document revision history

Date	Revision	Datasheet Status		
2024/9/10	Rev 1.0	Preliminary Datasheet		

#### Application data based on LSM-24-28

#### **Disclaimers**

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